

## 600V N-ch Multi-Epi Super-Junction MOSFET

## **General Features**

- Multi-Epi Process
- Proprietary New Super-Junction Technology
- $Arr R_{DS(ON),typ.}$ =0.11Ω@V<sub>GS</sub>=10V
- Low Gate Charge Minimize Switching Loss
- > Fast Recovery Body Diode

## **Applications**

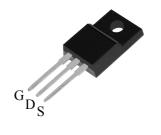
- Adaptor
- Charger
- SMPS Standby Power

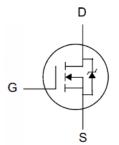
## **Ordering Information**

Part Number	Package	Brand		
SPTA60R130E	TO-220F	Z		

## (P6) Lead Free Package and Finish

BV <sub>DSS@TjMAX</sub>	R <sub>DS(ON),typ.</sub>	I <sub>D</sub>
650V	0.11Ω	25A





TO-220F

Package No to Scale

# **Absolute Maximum Ratings**

T<sub>C</sub>=25 °C unless otherwise specified

Symbol	Parameter —	Value	Unit	
Symbol	r ai ailletei	SPTA60R130E		
V <sub>DSS</sub>	Drain-to-Source Voltage	600		
V	Gate source voltage (static)	±20	V	
$V_{GSS}$	Gate source voltage (dynamic) AC (f>1Hz)	±30		
1	Continuous Drain Current @ T <sub>C</sub> = 25°C	25		
I <sub>D</sub>	Continuous Drain Current @ T <sub>C</sub> = 100°C	15	Α	
I <sub>DM</sub>	Pulsed Drain Current at V <sub>GS</sub> =10V <sup>[1]</sup>	75		
dv/dt	Reverse diode dv/dt	15	V/ns	
d <sub>iF</sub> /dt	Maximum diode commutation speed	50	A/us	
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>[2]</sup>	898	mJ	
P <sub>D</sub>	Power Dissipation	35	W	
T <sub>J</sub> & T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 150	${\mathbb C}$	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

### **Thermal Characteristics**

Symbol	Parameter	Max. Value	Unit	
Symbol	Faranieter	SPTA60R130E	Onit	
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	3.57	°C/W	
R <sub>θJA</sub> Thermal Resistance, Junction-to-Ambient		100		



## **Electrical Characteristics**

#### **OFF Characteristics**

T<sub>J</sub> =25℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	600			V	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA
I <sub>DSS</sub>	Drain-to-Source Leakage Current			1	uA	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V
ı	SS Gate-to-Source Leakage Current			+100	- Λ	V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V
I <sub>GSS</sub>				-100	nA	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V

### **ON Characteristics**

 $T_J$  =25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	<b>Test Conditions</b>
R <sub>DS(ON)</sub>	Static Drain-to-Source On-Resistance <sup>[3]</sup>		0.11	0.15	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =10.0A
$V_{GS(TH)}$	Gate Threshold Voltage	2.5		4.5	V	$V_{DS}=V_{GS}$ , $I_D=250uA$
gfs	Forward Transconductance <sup>[3]</sup>		10.5		S	Vps=10V,Ip=5.0A

### **Dynamic Characteristics**

Essentially independent of operating temperature

ynamic onaracteristics		Essentially independent of operating temperature				
Symbol	Parameter	Min.	Тур.	Max.	Unit	<b>Test Conditions</b>
C <sub>iss</sub>	Input Capacitance		1966		5E	$V_{GS}$ =0V, $V_{DS}$ =50V, f=10KH $_{Z}$
C <sub>oss</sub>	Output Capacitance		208		pF	
$R_G$	Gate resistance (Intrinsic)		5.8		Ω	f = 1.0MHz Open Drain
Qg	Total Gate Charge		48			V <sub>DD</sub> =400V, I <sub>D</sub> =11.3A, V <sub>GS</sub> =0 to 13V
$Q_{gs}$	Gate-to-Source Charge		8.5		nC	
$Q_{gd}$	Gate-to-Drain (Miller) Charge		8.5			
V <sub>plateau</sub>	Gate plateau voltage		6.3		V	

# **Resistive Switching Characteristics**

Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
td(ON)	Turn-on Delay Time		38		pF	$V_{DD}$ =400V, $I_{D}$ =11.3A, $V_{GS}$ =10V Rg=1.7 $\Omega$
trise	Rise Time		28			
td(OFF)	Turn-Off Delay Time		67			
tfall	Fall Time		21			



# **Source-Drain Body Diode Characteristics**

T<sub>J</sub>=25 °C unless otherwise specified

Symbol	Parameter	Min	Тур.	Max.	Unit	<b>Test Conditions</b>
I <sub>SD</sub>	Continuous Source Current <sup>[2]</sup>			25	A	Maximum Ratings
I <sub>SM</sub>	Pulsed Source Current <sup>[2]</sup>			75		
V <sub>SD</sub>	Diode Forward Voltage			1.2	V	I <sub>S</sub> =3.8A, V <sub>GS</sub> =0V
trr	Reverse Recovery Time		293		ns	V <sub>R</sub> =400V,V <sub>G</sub> s=0V I <sub>F</sub> =3.2A, di/dt =100A/μs
Qrr	Reverse Recovery Charge		3.9		uC	
Irrm	PeakReverseRecoveryCurrent		26.7		Α	

#### Note:

<sup>[1]</sup> Repetitive Rating: Pulse width limited by maximum junction temperature [2] L = 10mH, VDD= 80V, Starting TJ= 25°C [3] Pulse Test: Pulse width  $\leqslant$  380us, Duty Cycle $\leqslant$  2%



# **Test Circuits and Waveforms**

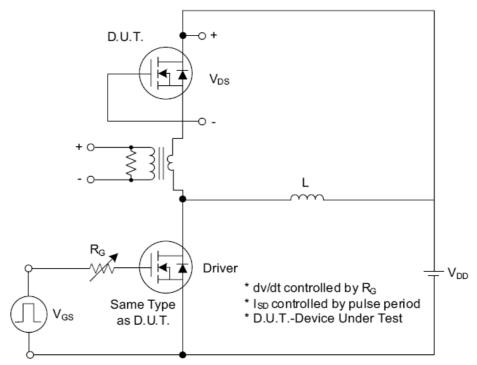


Fig. 1.1 Peak Diode Recovery dv/dt Test Circuit

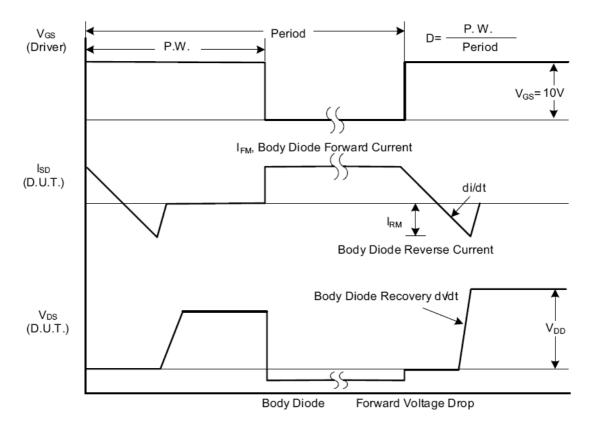
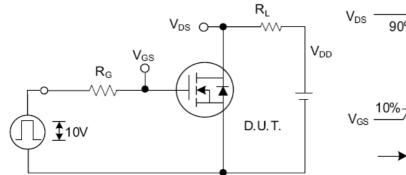


Fig. 1.2 Peak Diode Recovery dv/dt Waveforms



# Test Circuits and Waveforms (Cont.)



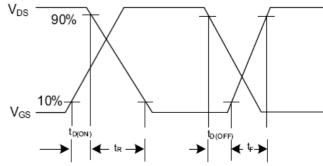


Fig. 2.1 Switching Test Circuit

Fig. 2.2 Switching Waveforms

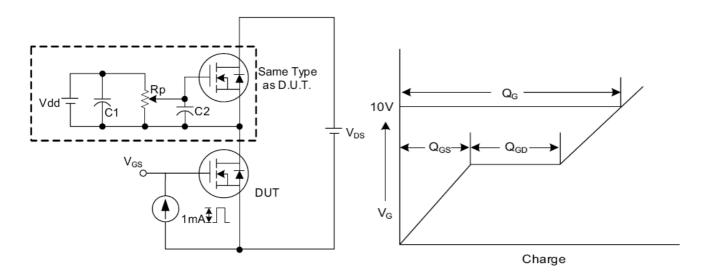


Fig. 3 . 1 Gate Charge Test Circuit

 $V_{DS}$  O  $V_{DS}$  O  $V_{DD}$   $V_{DD}$ 

Fig. 3.2 Gate Charge Waveform

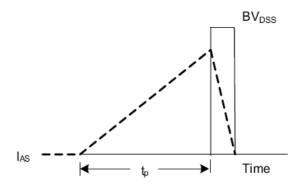


Fig. 4.1 Unclamped Inductive Switching Test Circuit

Fig. 4.2 Unclamped Inductive Switching Waveforms



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